

COMPLIANT

Vishay Siliconix

N-Channel 240-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)	
	2.9 at V _{GS} = 10 V	1.52		
240	2.95 at V _{GS} = 4.5 V	1.5	2.54 nC	
	3.5 at V _{GS} = 2.5 V	1.44		

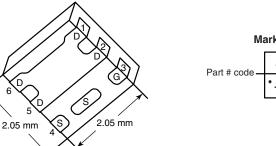
PowerPAK SC-70-6L-Single

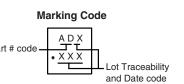
FEATURES

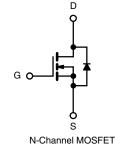
- Halogen-free
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK[®] SC-70 Package
- Small Footprint Area
- Low On-Resistance

APPLICATIONS

Boost Converter for Portable Devices







Ordering Information: SiA450DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	240	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		1.52		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C	I_	1.21		
	T _A = 25 °C	I _D	0.70 ^{a, b}		
	T _A = 70 °C		0.56 ^{a, b}	A	
Pulsed Drain Current		I _{DM}	1.5		
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	12.8		
Continuous Source-Drain Diode Current	T _A = 25 °C	'S	2.74 ^{a, b}		
	T _C = 25 °C		15		
Maximum Power Dissipation	T _C = 70 °C	PD	9.8	w	
Maximum Power Dissipation	T _A = 25 °C	D	3.3 ^{a, b}	vv	
	T _A = 70 °C		2.1 ^{a, b}		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature) ^{c, d}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, e}	t ≤ 5 s	R _{thJA}	30	38	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	6.5	8.1		

Notes: a. Surface Mounted on 1" x 1" FR4 board.

b. t = 5 s.

c. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

e. Maximum under Steady State conditions is 80 °C/W.

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SPECIFICATIONS $T_J = 25 \text{ °C}$ Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static	Symbol	Test conditions	WIII.	Typ.	IVIAA.	Onit		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	240			V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$			247.4		· ·		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		4.22		mV/°C		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	0.8	7.22	2.4	V		
Gate-Source Leakage		$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$	0.0		± 100	nA		
Gale-Source Leakage	I _{GSS}	$V_{\rm DS} = 240$ V, $V_{\rm GS} = 0$ V						
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 240 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 240 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			-1 μA			
	1	$V_{DS} = 240 \text{ V}, V_{GS} = 0 \text{ V}, 13 = 33 \text{ C}$ $V_{DS} \le 10 \text{ V}, V_{GS} = 10 \text{ V}$	1 5		- 10	- 10		
On-State Drain Current ^a	I _{D(on)}		1.5			A		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.70 \text{ A}$		2.4	2.9	Ω		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.65 \text{ A}$		2.46	2.95			
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 0.50 \text{ A}$		2.85	3.5			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 120 \text{ V}, \text{ I}_{D} = 0.70 \text{ A}$		3.14		S		
Dynamic ^b								
Input Capacitance	C _{iss}			167		pF		
Output Capacitance	C _{oss}	$V_{DS} = 120 V$, $V_{GS} = 0 V$, f = 1 MHz		10				
Reverse Transfer Capacitance	C _{rss}			3.4				
Tabal Qada Ohama	Q _g Q _{gs}	V_{DS} = 120 V, V_{GS} = 10 V, I_{D} = 0.70 A		4.69	7.035	nC		
Total Gate Charge		V _{DS} = 120 V, V _{GS} = 4.5 V, I _D = 0.70 A		2.54	3.81			
Gate-Source Charge				0.58				
Gate-Drain Charge	Q _{gd}			1.14				
Gate Resistance	Rg	f = 1 MHz		2		Ω		
Turn-On Delay Time	t _{d(on)}			13.7	21			
Rise Time	t _r	$V_{DD} = 120 \text{ V}, \text{ R}_{L} = 200 \Omega$		22	33	- ns		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 0.60$ A, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$		23	35			
Fall Time	t _f			19	29			
Turn-On Delay Time	t _{d(on)}			4.5	6.75			
Rise Time	t _r	V _{DD} = 120 V, R _I = 184 Ω		11	16.5			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 0.70 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		12	18			
Fall Time	t _f			15	22.5			
Drain-Source Body Diode Characterist								
Continuous Source-Drain Diode Current	Is	T _C = 25 °C			2.7			
Pulse Diode Forward Current	I _{SM}				12.8	A		
Body Diode Voltage	V _{SD}	I _S = 0.5 A, V _{GS} = 0 V		0.8	1.2	V		
Body Diode Reverse Recovery Time	t _{rr}	<u> </u>		50.2	75.3	ns		
Body Diode Reverse Recovery Time Crr Body Diode Reverse Recovery Charge Q _{rr}				68	102	nC		
Reverse Recovery Fall Time	t _a	$I_{\rm F} = 0.5$ A, di/dt = 100 A/µs, $I_{\rm el} = 25$ °C		25	102			
Reverse Recovery Rise Time				25		ns		
Heverse necovery rise Time	t _b			20.2				

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

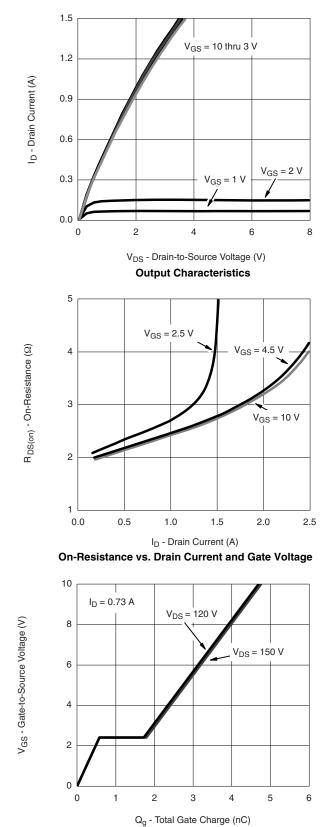
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



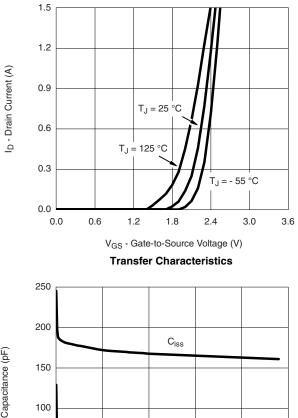
C - Capacitance (pF)

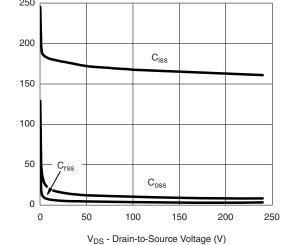
SiA450DJ Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

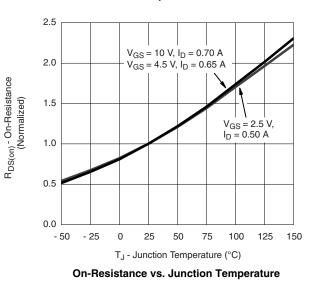


Gate Charge





Capacitance

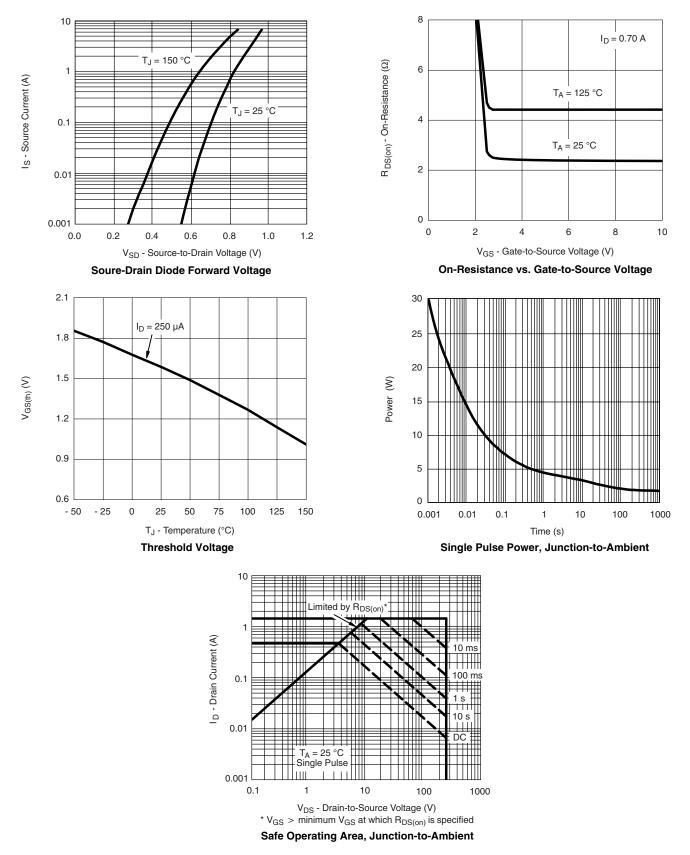


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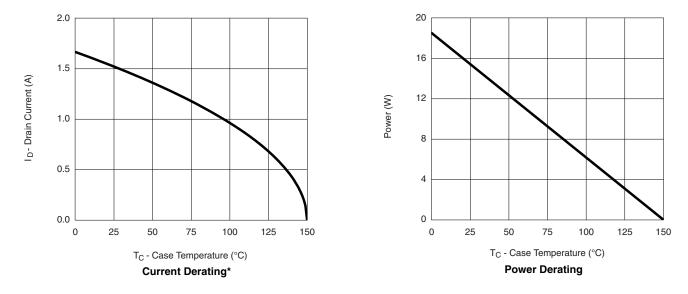
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

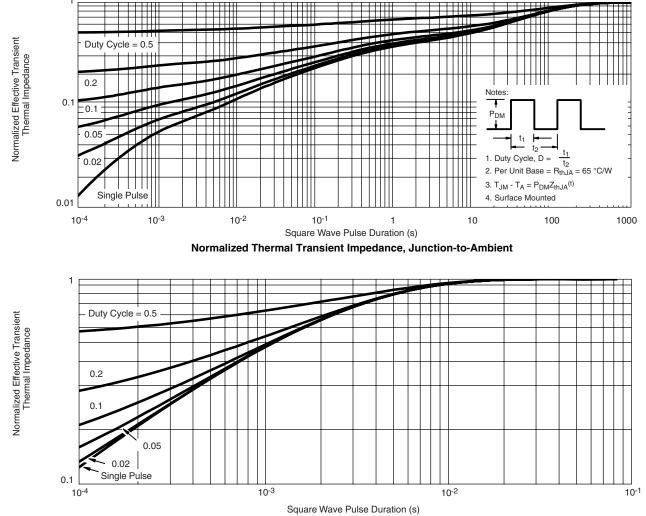


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?73603.



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